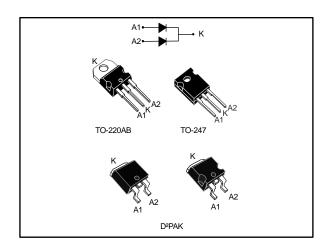
life.augmented

STPS3045C

Power Schottky rectifier

Datasheet - production data



Features

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Avalanche rated
- ECOPACK[®]2 compliant component for D²PAK on demand

Description

Dual center tap Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters. Packaged either in TO-220AB, TO-247, or D²PAK, this device is especially intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.

Table 1: Device summary

Symbol	Value			
I _{F(AV)}	2 x 15 A			
V_{RRM}	45 V			
V _F (typ.)	0.5 V			
T _j (max.)	175 °C (up to 200 °C in forward mode for D²PAK)			

Characteristics STPS3045C

1 Characteristics

Table 2: Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Paramete		Value	Unit	
V _{RRM}	Repetitive peak reverse voltage			45	V
I _{F(RMS)}	Forward rms current			30	Α
	Average forward current	Tc = 155 °C	Per diode	15	۸
I _{F(AV)}	δ = 0.5, square wave	1C = 155 C	Per device	30	Α
I _{FSM}	Surge non repetitive forward current	220	Α		
P _{ARM} ⁽¹⁾	Repetitive peak avalanche power $ \begin{array}{c} t_p = 10 \; \mu s, \\ T_j = 125 \; ^{\circ} C \end{array} $			430	W
T _{stg}	Storage temperature range		-65 to +175		
	Maximum operating junction temperat	175	°C		
Tj	Maximum operating junction temperat without reverse bias, t = 1 hour for D ² F	•	current	200	

Notes:

⁽¹⁾For pulse time duration deratings, please refer to Figure 3. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the STMicroelectronics Application notes AN1768, "Admissible avalanche power of Schottky diodes" and AN2025, "Converter improvement using Schottky rectifier avalanche specification".

Table 3: Thermal parameters

Table of the parameters						
Symbol	Parameter				Unit	
		TO-220AB / D2PAK	Per diode	1.60		
D	Junction to case	10-220AB / D2PAK	Total	0.95		
R _{th(j-c)}		TO 247	Per diode	1.5	°C/W	
		TO-247	Total	0.9		
R _{th(c)}	Coupling	TO-220AB / D2PAK/ TO-247		0.3		

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_{j \text{ (diode1)}} = P_{\text{(diode1)}} x R_{\text{th(j-c)}} \text{ (per diode)} + P_{\text{(diode2)}} x R_{\text{th(c)}}$$

 $^{^{(2)}(}dP_{tot}/dT_j) < (1/R_{th(j-a)}) \ condition \ to \ avoid \ thermal \ runaway \ for \ a \ diode \ on \ its \ own \ heatsink.$

STPS3045C Characteristics

Table 4: Static electrical characteristics (per diode)

	Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
Ī	L (1)	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-		200	μΑ
	I _R ⁽¹⁾		T _j = 125 °C		-	11	40	mΑ
Ī		V _F ⁽¹⁾ Forward voltage drop	T _j = 125 °C	I _F = 15 A	-	0.5	0.57	
	V _F ⁽¹⁾		T _j = 25 °C		-		0.84	V
			T _j = 125 °C	I _F = 30 A	-	0.65	0.72	

Notes:

To evaluate the conduction losses use the following equation:

$$P = 0.42 \text{ x } I_{F(AV)} + 0.01 \text{ x } I_{F^2(RMS)}$$

 $^{^{(1)}\}text{Pulse}$ test: t_p = 380 $\mu\text{s},\,\delta$ < 2%

Characteristics STPS3045C

1.2 Characteristics (curves)

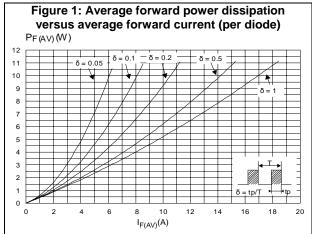


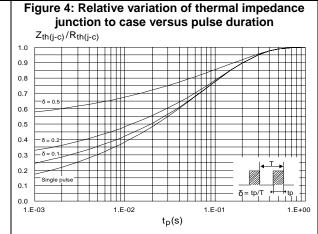
Figure 2: Average forward current versus ambient temperature (δ = 0.5, per diode) $I_{F(AV)}(A)$ R_{th(j-a)} R_{th(j-c)} 16 12 10 2 0 50 125 175 0 25 150 Tamb(°C)

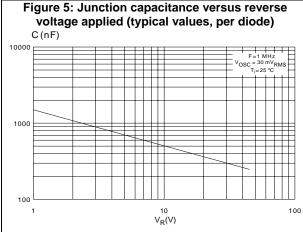
Figure 3: Normalized avalanche power derating versus pulse duration (Tj = 125 °C)

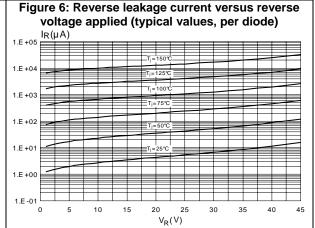
PARM(tp)
PARM(10 µs)

0.01

1 10 t_p(µs) 100 1000







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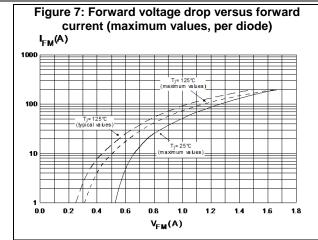


Figure 8: Thermal resistance junction to ambient versus copper surface under tab $R_{th(j\cdot a)}(^{\circ}C/W)$ 80 D²PAK 70 = 35 µm -Epoxy printed board FR4, copper thickness 60 50 40 30 20 10 0 10 15 0 20 40 $S_{\text{Ou}}(\text{cm}^2)$



Package information STPS3045C

2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0
- Recommended torque value: 0.55 N·m (for TO-220AB and TO-247)
- Maximum torque value: 0.7 N·m (for TO-220AB)
- Maximum torque value: 1.0 N⋅m (for TO-247)

2.1 TO-220AB package information

Figure 9: TO-220AB package outline øΡ H1 D1 L20 L30 b1(X3) -- b (X3)

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Table 5: TO-220AB package mechanical data

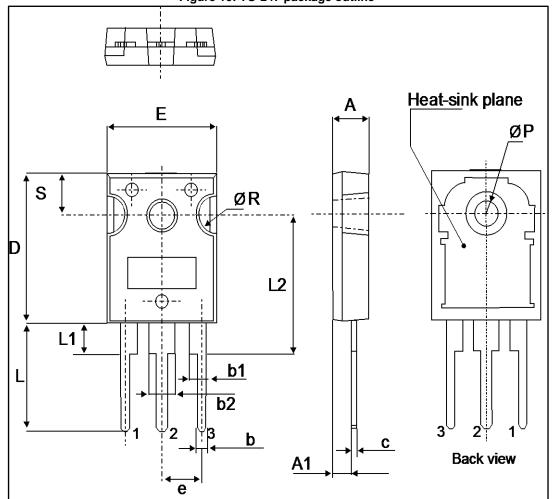
	Dimensions				
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.173	0.181	
b	0.61	0.88	0.024	0.035	
b1	1.14	1.55	0.045	0.061	
С	0.48	0.70	0.019	0.028	
D	15.25	15.75	0.600	0.620	
D1	1.27	typ.	0.050	O typ.	
Е	10.00	10.40	0.394	0.409	
е	2.40	2.70	0.094	0.106	
e1	4.95	5.15	0.195	0.203	
F	1.23	1.32	0.048	0.052	
H1	6.20	6.60	0.244	0.260	
J1	2.40	2.72	0.094	0.107	
L	13.00	14.00	0.512	0.551	
L1	3.50	3.93	0.138	0.155	
L20	16.40 typ.		0.640	6 typ.	
L30	28.90 typ.		1.138	8 typ.	
ØP	3.75	3.85	0.148	0.152	
Q	2.65	2.95	0.104	0.116	



Package information STPS3045C

2.2 TO-247 package information

Figure 10: TO-247 package outline



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STPS3045C Package information

Table 6: TO-247 package mechanical data

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	4.85		5.15	0.191		0.203
A1	2.20		2.60	0.086		0.102
b	1.00		1.40	0.039		0.055
b1	2.00		2.40	0.078		0.094
b2	3.00		3.40	0.118		0.133
С	0.40		0.80	0.015		0.031
D ⁽¹⁾	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е	5.30	5.45	5.60	0.209	0.215	0.220
L	14.20		14.80	0.559		0.582
L1	3.70		4.30	0.145		0.169
L2		18.50			0.728	
ØP ⁽²⁾	3.55		3.65	0.139		0.143
ØR	4.50		5.50	0.177		0.217
S	5.30	5.50	5.70	0.209	0.216	0.224

Notes:

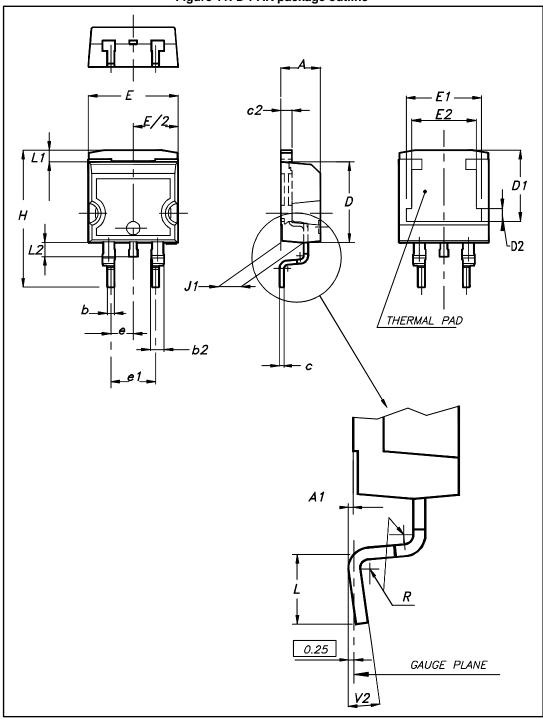
 $^{^{(1)}}$ Dimension D plus gate protusion does not exceed 20.5 mm

 $[\]ensuremath{^{(2)}}\mbox{Resin}$ thickness around the mounting hole is not less than 0.9 mm.

Package information STPS3045C

2.3 D²PAK package information

Figure 11: D²PAK package outline





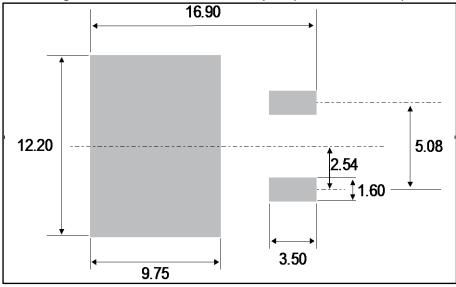
This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

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Table 7: D²PAK package mechanical data

	Dimensions				
Ref.	Millim		Incl	nes	
	Min.	Max.	Min.	Max.	
А	4.36	4.60	0.172	0.181	
A1	0.00	0.25	0.000	0.010	
b	0.70	0.93	0.028	0.037	
b2	1.14	1.70	0.045	0.067	
С	0.38	0.69	0.015	0.027	
c2	1.19	1.36	0.047	0.053	
D	8.60	9.35	0.339	0.368	
D1	6.90	8.00	0.272	0.311	
D2	1.10	1.50	0.043	0.060	
Е	10.00	10.55	0.394	0.415	
E1	8.10	8.90	0.319	0.346	
E2	6.85	7.25	0.266	0.282	
е	2.54	typ.	0.1	00	
e1	4.88	5.28	0.190	0.205	
Н	15.00	15.85	0.591	0.624	
J1	2.49	2.90	0.097	0.112	
L	1.90	2.79	0.075	0.110	
L1	1.27	1.65	0.049	0.065	
L2	1.30	1.78	0.050	0.070	
R	0.4 t	ур.	0.0	15	
V2	0°	8°	0°	8°	

Figure 12: D²PAK recommended footprint (dimensions in mm)





Ordering information STPS3045C

3 Ordering information

Table 8: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS3045CT	STPS3045CT	TO-220AB	1.9 g	50	Tube
STPS3045CG	STPS3045CG	D²PAK	1 20 ~	50	Tube
STPS3045CG-TR	STPS3045CG	DEPAR	1.38 g	1000	Tape and reel
STPS3045CW	STPS3045CW	TO-247	4.46 g	30	Tube

4 Revision history

Table 9: Document revision history

Date	Revision	Changes
Jul-2003	6E	Last update.
06-Nov-2012	7	Removed SOT-93 and TOP-3I packages. Table 2: Operating range (T _j) extension from -40 to +175° C, I _{F(AV)} per diode updated to 15 A. Updated "Total" values in Table 3. Updated tables in Section 2: Package information.
04-Apr-2013	8	Added value for maximum T_j in forward mode. Updated Table 9.
02-Aug-2016	9	Updated D ² PAK package information. Removed I ² PAK and TO-220FPAB package information.

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